PCN # 2067B

DATE: March 18, 2021

EXPECTED PCN SHIP DATE: March 18, 2021



Quality Assurance 160 Rio Robles San Jose, CA 95134

www.maximintegrated.com

PROCESS CHANGE NOTICE
X PRODUCT CHANGE NOTICE

MAXIM INTEGRATED HEREBY ISSUES NOTIFICATION OF CHANGE THAT MAY AFFECT THE FOLLOWING CATEGORIES: DESIGN WAFER FAB X ASSEMBLY **ELEC/MECH SPECS** TEST AFFECTED PRODUCT: Ordering P/N: (See PN listing XLS in PCN ZIP file) CHANGE FROM: Devices in WLP package (Maxim package CHANGE TO: codes W563A4+1, W563A4+2) current WLP processing at ASEK (Advanced Semiconductor Engineering, Kaohsiung, Additional WLP processing at ASECL (Advanced Semiconductor Engineering, Chung-Li, Taiwan) Taiwan), or JCAP (Jiangyin Changdian Advanced Packaging Co. LTD, Jiangsu, China JUSTIFICATION: -The addition of ASECL is to expand capacity, improve cycle time and to ensure supply continuity for our customers. A qualification report is attached for reference (R41106CQ_ASECL_WLP). There are no regulatory compliance changes to the material content of these devices.

TRACEABILITY: Maxim Integrated maintains full traceability by device marking, packaging labels and shipment documents.

Maxim Integrated's Change Notification System is designed to keep our customer base apprised of major product, manufacturing, or facility improvements.

Nasser Ali Chaouche

Nasser AliChaouche / PCN Coordinator

For further information, please contact either of the people listed below.

There are no changes to Form/Fit/Function at new assembler for these devices.

Contact your local Maxim Integrated Company Representative or

Nasser AliChaouche, PCN Coordinator 408-601-5660 / pcn.coordinator@maximintegrated.com

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